Middle Power LED PLCC Series

o.2W White SPMWHT3215A3



Features & Benefits

Package: Au Plated 2 pad design package with silicone resin

• Dimension: 3.2 mm x 2.8 mm

• Technology : Epi-up

Color Coordinate Group : Appropriate to ECE

• Chip Configuration: 1 chip

• ESD Voltage : Up to 2 kV acc. to ISO 10605-contact

Viewing Angle: 120°

• Qualifications: The product qualification test based on the guidelines of AEC-Q101-REV-C.



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1. Characteristics

a) Typical Characteristics

ltem	Symbol	Value	Unit.
Luminous Flux (I _F = 50 mA)	cd	Тур. 3.5	cd
Forward Voltage (I _F = 50 mA)	V _F	Тур. 3.1	V
Viewing Angle	φ	Тур. 120	Deg
Reverse Current	I_{R}	10	μΑ
Real Thermal Resistance	D	Тур. 68	IZAAZ
(Junction to Solder point)	R _{th_} J-S (Real)	Max. 79	K/W
Electrical Thermal Resistance	D	Тур. 60	
(Junction to Solder point)	R _{th_J-S} (Elec.)	Max. 70	K/W
Radian Surface	Α	4.52	mm²
Note:			

^[1] Measurement condition: LED (T_j) = Ambient temperature (T_a) , by applying pulse current for under 25ms.

b) Absolute Maximum Rating

ltem	Symbol	Rating	Unit
Ambient / Operating Temperature	Ta	-40 ~ +110	°C
Storage Temperature	T_{stg}	-40 ~ +110	°C
LED Junction Temperature	Tj	125	°C
Maximum Forward current ^[2] (T _j : 25°C) ^[3]	l _F	70	mA
Minimum Forward current ^[2] (T _j : 25°C) ^[3]	l _F	10	mA
Maximum Reverse current		Do not apply for reverse current	
ESD Sensitivity ^[4]	-	±2 HBM	kV
Noto:			

Note:

- [2] Unpredictable performance may be resulted by driving the product at below Min. I_F or above Max. I_F. But there will be no damage to the product.
- [3] The measurement condition means that temperature dependence is excluded by applying pulse current for under 25ms.
- [4] It is included the device to protect the product from ESD.

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	М	W	Н	Т	3	2	3	5	Α	3	Α	В	С	D	Е	F

Digit	PKG Information
1 2	company name and Samsung LED PKG (SP for Samsung PKG)
3	power variant (M for automotive middle power)
4 5	color variant (WH for automotive white color)
6	LED PKG version (T for initial version)
7 8 9	product configuration and type (323 for automotive 3228 PKG Au plate type)
10	Max power (5 for 50mA)
11	specific property (A for Automotive)
12	CRI Variant (3 for CRI Min. 70)
13 14	forward voltage property
15 16	CIE coordination property
17 18	luminous flux property

a) Luminous Intensity Bins $^{[5]}(I_F=50\ mA,\,T_j=25\ ^{o}C)$

Cumbal	Bin Code	Intensity Range (cd)			nge (lm)
Symbol	Bill Code	Min	Max	Min	Max
Φ	A2	3.0	4.0	9.0	12.0
	A3	4.0	5.0	12.0	15.0

b) Voltage Bins $^{[5]}$ (I_F= 50 mA, T_j= 25 $^{\circ}$ C)

Symbol	Bin Code	Voltage Range (V)			
Зушьы	Biii Code	Min	Max		
	C1	2.7	3.0		
V_{F}	C2	3.0	3.3		
	C3	3.3	3.6		

Note:

[5] Luminous intensity measuring equipment: CAS140CT

 Φ_V and V_F tolerances are ±7% and ±0.1 V, respectively.

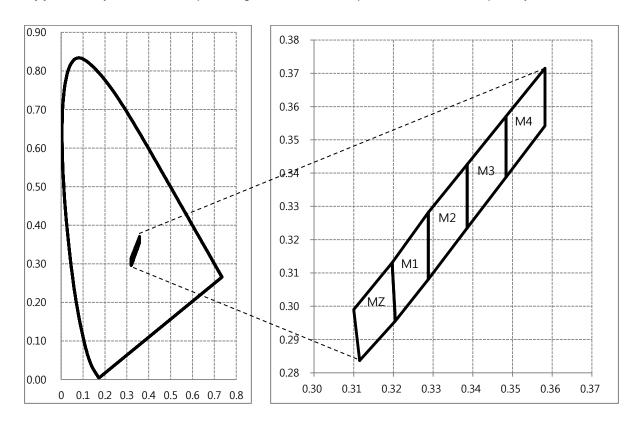
Downloaded from Arrow.com.

c) Color Bins $^{[6]}$ (I_F= 50 mA)

Symbol	Bin Code		C	×			C	- -y	
	MZ	0.3115	0.3205	0.3197	0.3100	0.2837	0.2956	0.3131	0.2990
	M1	0.3205	0.3197	0.3288	0.3288	0.2956	0.3131	0.3282	0.3081
C_x , C_y	M2	0.3288	0.3288	0.3386	0.3386	0.3081	0.3282	0.3426	0.3235
	M3	0.3386	0.3386	0.3484	0.3484	0.3235	0.3426	0.3571	0.3388
	M4	0.3484	0.3484	0.3582	0.3582	0.3388	0.3571	0.3715	0.3542

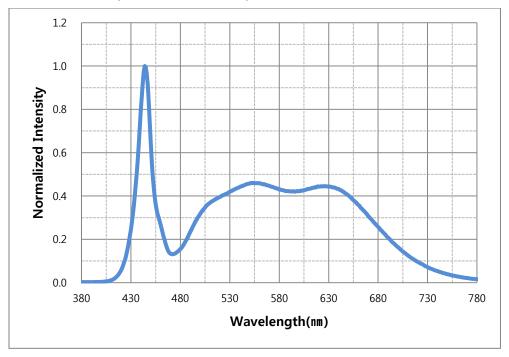
Note

[6] Chromaticity coordinates: C_x , C_y according to CIE 1931. C_x and C_y tolerances are ± 0.005 , respectively.

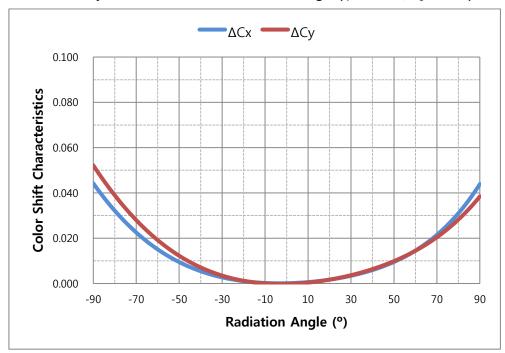


3. Typical Characteristics Graphs

a) Spectrum Distribution (I $_{\text{F}}$ = 50 mA, T $_{\text{s}}$ = 25 $^{\text{0}}\text{C})^{[7]}$



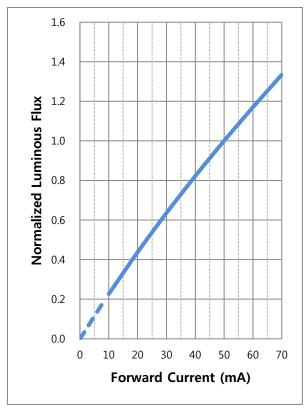
b) Typical Chromaticity Coordinate Shift vs Radiation Angle (I_F = 50 mA, T_s = 25 °C) ^[7]

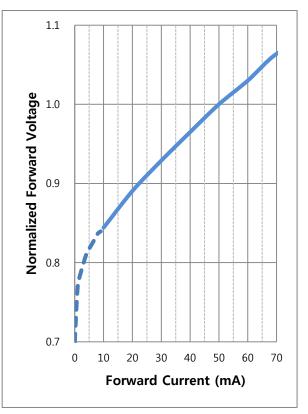


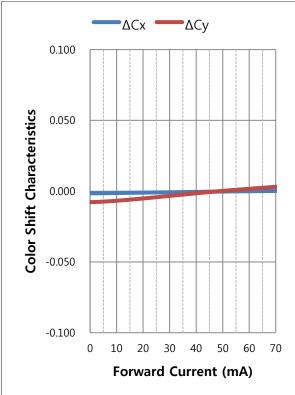
Note:

[7] The measurement condition means that temperature dependence is excluded by applying pulse current for under 25ms.

c) Forward Current Characteristics (T $_s$ = 25 o C) $^{[8]}$



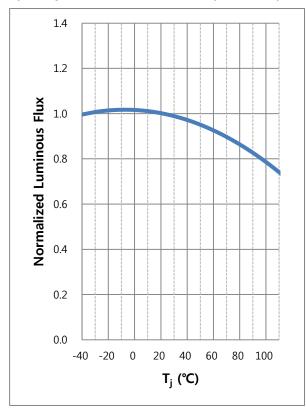


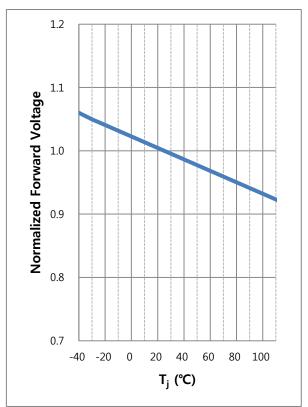


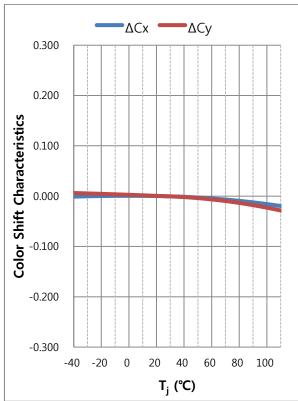
Note:

[8] The measurement condition means that temperature dependence is excluded by applying pulse current for under 25ms.

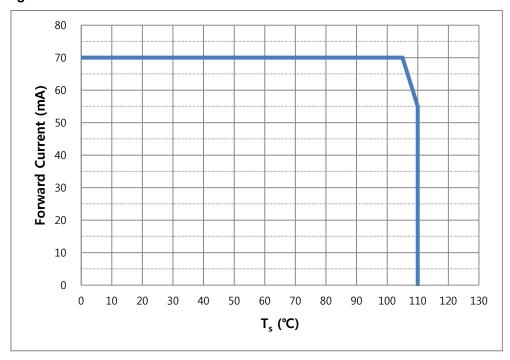
d) Temperature Characteristics (I_F= 50 mA)







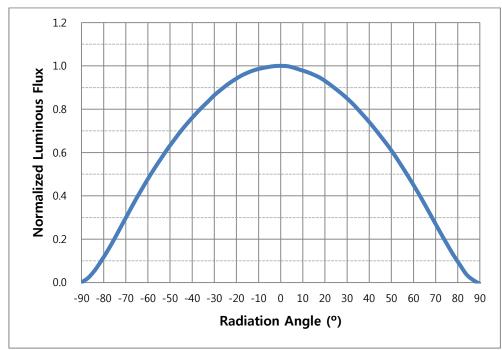
e) Derating Curve [9]



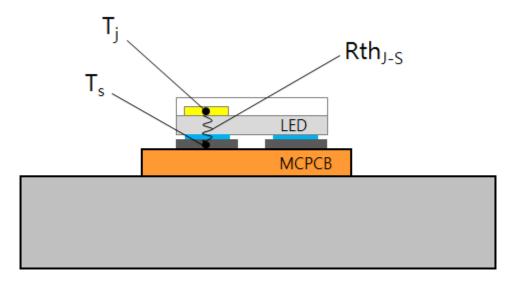
Note:

[9] The measurement condition means that temperature dependence is excluded by applying pulse current for under 25ms.

f) Beam Angle Characteristics (I_F= 50 mA, T_s= 25 °C)



4. Soldering Temperature Location

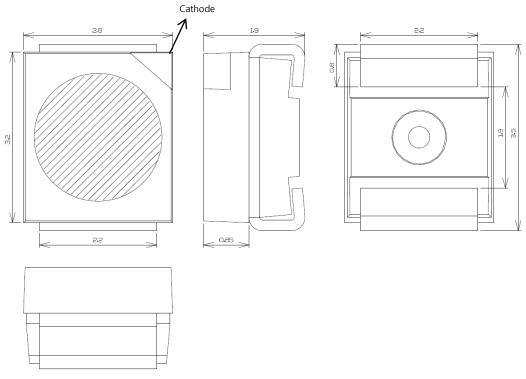


T_j: Temperature of Junction

T_s: Temperature of Solder Pad

 $R_{\text{th_J-S}}\!\!:$ Thermal Resistance from Junction to Solder Pad

5. Mechanical Dimension



Note:

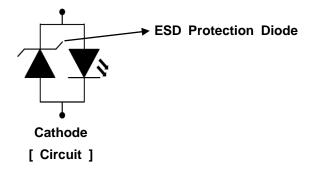
Unit: mm, Tolerance: ±0.1mm

a) Pick and Place

Do not place pressure on the resin lens (hatch area).

The maximum compressing force is 15N in the polymer.

b) Electric Schematic Diagram

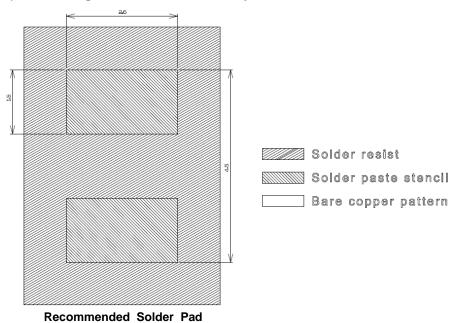


c) Material Information

Description	Material
Lead flame	PLCC
LED Die	Epi-up
Wire	Au
Resin Mold	Silicon

6. Soldering Conditions

a) Pad Configuration & Solder Pad Layout

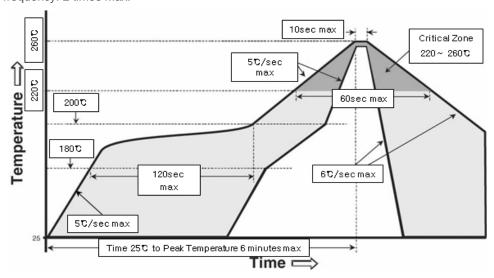


Notes:

Unit: mm, Tolerance: ±0.1mm

b) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



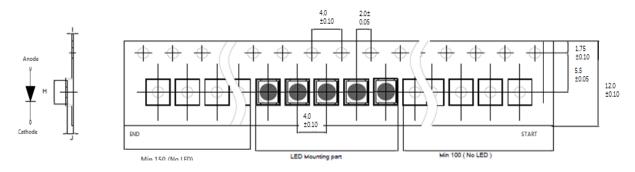
c) Manual Soldering Conditions

Not more than 5 seconds @ max 300 $^{\rm o}{\rm C},$ under soldering iron. (One time only)

7. Tape & Reel

a) Taping Dimension

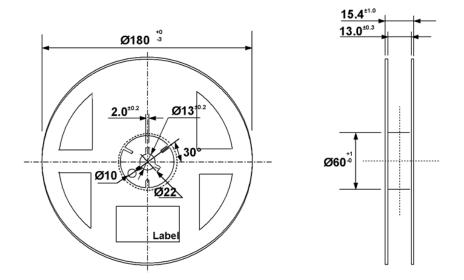
User feed direction →



Note:

Unit: mm, LED taping quantity: 2,000EA / Reel

b) Reel Dimension



Notes:

Unit: mm, Tolerance: ±0.2mm

8. Label Structure

a) Product Labeling Information



N.B) Denoted rank is the only example.

b) Bin Code Structure

AB: Forward Voltage (V_F) Bin (refer to page. 5)

CD: Color bin (Cx, Cy) (refer to page. 6)

EF: Luminous Flux (I_V) Bin (refer to page. 5)

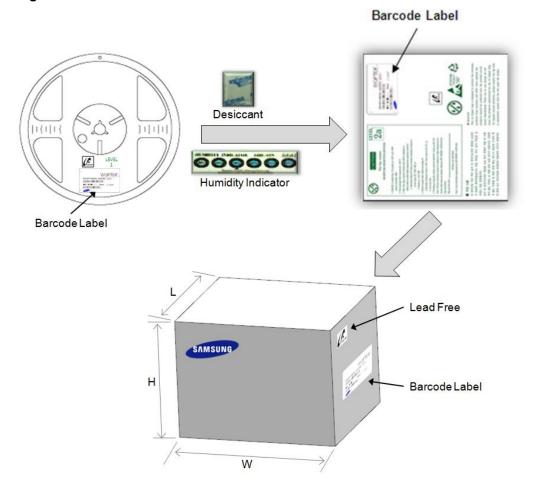
c) Lot Number Structure

The lot number is composed of the following characters:

No.	Information
1	Production Site : S:SAMSUNG LED, G:GOSIN CHINA
2	LED
3	Product State A :Normality, B :Bulk, C :First Production, R :Reproduction, S :Sample
4	Year : Y:2014, Z:2015, A:2016, B:2017, C:2018
5	Month : 1 ~ 9, A, B
6	Day : 1 ~ 9, A, B ~ V
789	Product number : 1 ~ 999
abc	Reel Number : 1 ~ 999

9. Packing Structure

a) Packing Process



Dimension of Transportation Box in mm

Width	Length	Height
220	245	182

10. Precautions in Handling & Use

- 1) For over-current-proof function, customers are recommended to apply resistors to prevent sudden change of the current caused by slight shift of the voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA is recommended to use.
- 3) When the LEDs illuminate, operating current should be decided after considering the ambient maximum temperature.
- 4) LEDs must be stored in a clean environment.
 - If the LEDs are to be stored for 3 months or more after being shipped from Samsung Electronics, they should be packed by a sealed container with nitrogen gas injected.
 - (Shelf life of sealed bags: 12 months, temp. ~40 °C, ~90 % RH)
- 5) After storage bag is open, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 $^{\circ}$ C/60 %RH.
 - b. Stored at <10 %RH.
- 6) Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23±5 °C.
- 8) Devices must be baked for 1 day at 60±5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
 - If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices.
 - Damaged LEDs may show some unusual characteristics such as increase in leak current, lowered turnon voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (volatile organic compounds) may be occurred by adhesives, flux, hardener or organic additives which are used in luminaires (fixture) and LED silicone bags are permeable to it. It may lead a discoloration when LED expose to heat or light.
 - This phenomenon can give a significant loss of light emitted (output) from the luminaires (fixtures). In order to prevent these problems, we recommend you to know the physical properties for the materials used in luminaires, it requires selecting carefully.
- 11) Risk of Sulfurization (or Tarnishing)
 - The lead frame from Samsung Electronics is a plated package and it may change to black(or dark colored) when it is exposed to Ag (a), Sulfur (S), Chlorine (CI) or other halogen compound. It requires attention
 - Sulfide (Sulfurization) of the lead frame may cause a change of degradation intensity, chromaticity coordinates and it may cause open circuit in extreme cases. It requires attention.
 - Sulfide (Sulfurization) of the lead frame may cause of storage and using with oxidizing substances together. Therefore, LED is not recommend to use and store with the below list.
 - : Rubber, Plain paper, lead solder cream etc.

11. Company Information



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